

Docket No. 03-211

Declaration and Power of Attorney For Patent Application English Language Declaration

As a Delow Hairieu II	iveritor, i hereby deciare i	inat.	
My residence, post of	office address and citizens	ship are as stated below next to m	ny name,
first and joint invento	_	tor (if only one name is listed belo ed below) of the subject matter w led	•
BIOMEDICAL SUPER METHOD	RELASTIC TI-BASED ALLO	DY, ITS PRODUCT AND ITS MANUE	FACTURING
the specification of v	vhich		
is attached heret	0.	•	
was filed on ○	ctober 30, 2003	as United States Application No	. or PCT International
	per 10/697,407	_	
and was amende			
		(if applicable)	
I acknowledge the d	as amended by any ame uty to disclose information continuation-in-part appleate of the prior application	rstand the contents of the above ndment referred to above. In which is material to patentability ciations, material information when and the national or PCT internation.	as defined in 37 CFR and the decame available
application(s) for painternational applica America, listed below patent, inventor's or	atent, inventor's or plant tion which designated a v and have also identified	r 35 U.S.C. 119(a)-(d) or (f), or breeder's rights certificate(s), out least one country other than below, by checking the box, any tificate(s), or any PCT internation ich priority is claimed.	or 365(a) of any PCT the United States of foreign application for
Prior Foreign Applica	ation(s)		Priority Not Claimed
2003-199412	Japan	18 July 2003	
(Number) 2003-199413	(Country) Japan	(Day/Month/Year Filed) 18 July 2003	
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	

Prior Foreign Appli	cation(s)		Priority Not Claimed
2003-199412	Japan	18 July 2003	
(Number) 2003-199413	(Country) Japan	(Day/Month/Year Filed) 18 July 2003	
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	

(Application Serial No.)	(Filing Date)	•
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
Section 365(c) of any PCT Internatinsofar as the subject matter of ea United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me	onal application designating ch of the claims of this ap application in the manner the duty to disclose to the to be material to patental e between the filing date of	any United States application(s), og the United States, listed below and plication is not disclosed in the prioprovided by the first paragraph of 35 United States Patent and Trademark bility as defined in Title 37, C. F. R. the prior application and the national
Section 365(c) of any PCT Internatinsofar as the subject matter of ea Jnited States or PCT International J.S.C. Section 112, I acknowledge Office all information known to me Section 1.56 which became available	onal application designating ch of the claims of this ap application in the manner the duty to disclose to the to be material to patental e between the filing date of	y the United States, listed below and plication is not disclosed in the prioprovided by the first paragraph of 35 United States Patent and Trademark ility as defined in Title 37, C. F. R.
Section 365(c) of any PCT Internatinsofar as the subject matter of ea Jnited States or PCT International J.S.C. Section 112, I acknowledge Office all information known to me Section 1.56 which became available	onal application designating ch of the claims of this ap application in the manner the duty to disclose to the to be material to patental e between the filing date of	y the United States, listed below and plication is not disclosed in the prioprovided by the first paragraph of 35 United States Patent and Trademark ility as defined in Title 37, C. F. R.
Section 365(c) of any PCT Internations of a section 365(c) of any PCT Internations of earth of the subject matter of earth of the section 365(c) of the section 1.56 which became available or PCT International filing date of this	onal application designating ch of the claims of this ap application in the manner the duty to disclose to the to be material to patental e between the filing date of application:	g the United States, listed below and plication is not disclosed in the priorovided by the first paragraph of 35 United States Patent and Trademark illity as defined in Title 37, C. F. R. the prior application and the national (Status)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

Frederick L. Tolhurst 28,123 24,455 Thomas C. Wettach 41,373 Christine W. Trebilcock 51,022 John A. Monocello, III

Send Correspondence to: Frederick L. Tolhurst

Cohen & Grigsby, P.C.

11 Stanwix Street, 15th Floor Pittsburgh, Pennsylvania 15222

Direct Telephone Calls to: (name and telephone number)

Frederick L. Tolhurst (412) 297-4960

Full name of sole or first inventor TANAKA, Toyonobu	
Sole or first inventor's signature Tancha Tayroba	Date 04/28/2004
Residence	
Japan	
Citizenship	
Japan	
Post Office Address c/o Furukawa Techno Material Co., Ltd.	
5-1-8, Higashi-yawata, Hiratsuka-city, Kanagawa 254-0016 Japan	:

Full name of second inventor, if any HORIKAWA, Hiroshi			
Second inventor's signature			Date 04/28/2004
Residence Japan		1	
Citizenship Japan			
Post Office Address c/o Furukawa Techno Material Co., Ltd.			
5-1-8, Higashi-yawata, Hiratsuka-city, Kanagaw	va 254-0016 Japan		

Third inventor's signature	Date 04/28/2004
Residence Japan	
Citizenship Japan	
Post Office Address 5-5-26, Matsushiro, Tsukuba-city, Ibaraki 305-0035 Japan	

HOSODA, Hideki	
Fourth inventor's signature	Date
Residence	
Japan	
Citizenship	
Japan	
Post Office Address	
2-41-21-204, Fujigaoka, Aoba-ku, Yokohama-city	•

ifth inventor's signature	Date
na area o dignatare	Date
Residence	
lapan	
Citizenship	
apan	
Post Office Address	
o Hosoda Lab., Precision and Intelligen	nce Laboratory Tokyo Institute of Technology

Sixth inventor's signature HASHIMOTO, Satory	Date 04/28/2004
Residence Japan	
Citizenship Japan	
Post Office Address c/o Miyazaki Lab., Institute of Materials Science University of Tsukuba	

Third inventor's signature	Date
Residence	
Japan	
Citizenship	
Japan	
Post Office Address	
5-5-26, Matsushiro, Tsukuba-city, Ibaraki 305-0035 Japan	

Full name of fourth inventor, if any HOSODA, Hideki

Fourth inventor's signature / Date 04/28/2004

Residence Japan

Citizenship Japan

Post Office Address 2-41-21-204, Fujigaoka, Aoba-ku, Yokohama-city

Kanagawa 227-0043 Japan

Full name of fifth inventor, if any
FUKUI, Yusuke

Fifth inventor's signature

Yusuke Fukui

Residence
Japan

Citizenship
Japan

Post Office Address
c/o Hosoda Lab., Precision and Intelligence Laboratory Tokyo Institute of Technology

4259 Nagatsuta, Midori-ku, Yokohama 226-8503 Japan

Full name of sixth inventor, if any
HASHIMOTO, Satoru

Sixth inventor's signature

Residence
Japan

Citizenship
Japan

Post Office Address
c/o Miyazaki Lab., Institute of Materials Science University of Tsukuba

1-1-1, Tennodai, Tsukuba-city, Ibaraki 305-8573 Japan

OMATSU, Yoshinori Seventh inventor's signature	Date
Seventh inventor's signature	04/28/200
Residence	, , ,
Japan Citizenship	
Japan	
Post Office Address	
c/o Miyazaki Lab., Institute of Materials of Science University of Tsukub	ua .
1-1-1, Tennodai, Tsukuba-city, Ibaraki 305-8573 Japan	
Full name of eighth inventor, if	
Eighth inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
	
Full name of ninth inventor, if any	
Ninth inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
Full name of tenth inventor, if any	
Tenth inventor's signature	Date
Residence	
Citizenship	
Post Office Address	